

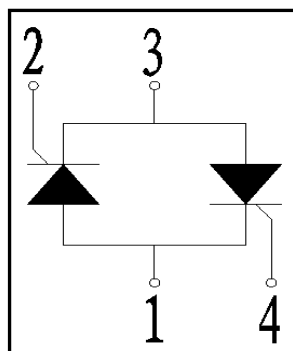
**Features**

- Isolation voltage 3500 V~
- Industrial Standard Package
- High Surge Capability
- Glass Passivated Chips
- Simple Mounting
- Electrically Isolated by DBC Ceramic



**Applications**

- DC Motor Control and Drives
- Battery Charges
- Welders
- Power Converters
- Lighting Control
- Heat and Temperature Control



**Advantages**

- Space and weight savings
- Improved temperature and power cycling

**ABSOLUTE MAXIMUM RATINGS**

T<sub>C</sub>=25°C unless otherwise specified

Symbol	Test Condition	Value	Unit
V <sub>RRM</sub> / V <sub>DRM</sub>		1600	V
I <sub>T(AV)</sub>	T <sub>C</sub> =85°C, 180° conduction, half sine wave;	40	A
I <sub>T(RMS)</sub>	as AC switch;	100	A
I <sub>TSM</sub>	T <sub>J</sub> =45°C, t=10ms (50Hz), sine, V <sub>R</sub> =0;	850	A
	T <sub>J</sub> =45°C, t=8.3 ms (60Hz), sine, V <sub>R</sub> =0;	890	
	T <sub>J</sub> =45°C, t=10ms (50Hz), sine, V <sub>R</sub> =V <sub>RRM</sub> ;	715	
	T <sub>J</sub> =45°C, t=8.3 ms (60Hz), sine, V <sub>R</sub> = V <sub>RRM</sub> ;	750	
i <sup>2</sup> <sub>t</sub>	T <sub>J</sub> =45°C, t=10ms (50Hz), sine, V <sub>R</sub> =0;	3.61	K A <sup>2</sup> s
	T <sub>J</sub> =45°C, t=8.3 ms (60Hz), sine, V <sub>R</sub> =0;	3.3	
	T <sub>J</sub> =45°C, t=10ms (50Hz), sine, V <sub>R</sub> =V <sub>RRM</sub> ;	2.56	
	T <sub>J</sub> =45°C, t=8.3 ms (60Hz), sine, V <sub>R</sub> = V <sub>RRM</sub> ;	2.33	
I <sub>DRM</sub> /I <sub>RRM</sub>	V <sub>D</sub> =V <sub>R</sub> =1600V, gate open circuit;	0.5	mA
I <sub>DRM</sub> /I <sub>RRM</sub>	T <sub>J</sub> =125°C, V <sub>D</sub> =V <sub>R</sub> =1600V, gate open circuit;	15	mA
dv/dt	T <sub>J</sub> =125°C, exponential to 67% rated V <sub>DRM</sub>	500	V/us
V <sub>ISOL</sub>	50Hz, all terminals shorted, t=1s, I <sub>ISOL</sub> ≤1mA ;	3500	V~
T <sub>J</sub>	Max. junction operating temperature range	-40~125	°C
T <sub>STG</sub>	Max. storage temperature range	-40~125	°C

**ELECTRICAL CHARACTERISTICS** $T_C=25^{\circ}\text{C}$  unless otherwise specified

Symbol	Test Condition	Min.	Typ.	Max.	Unit
$V_{TO}$	$16.7\% \times p \times I_{AV} < I < p \times I_{AV}, T_J = 130^{\circ}\text{C};$			0.88	V
	$I > p \times I_{AV}, T_J = 130^{\circ}\text{C};$			0.91	V
$r_t$	$16.7\% \times p \times I_{AV} < I < p \times I_{AV}, T_J = 130^{\circ}\text{C};$			5.9	m $\Omega$
	$I > p \times I_{AV}, T_J = 130^{\circ}\text{C};$			5.74	m $\Omega$
$I_H$	$V_{AK} = 6\text{V}$ , resistive load;			200	mA
$I_L$	Anode supply = 6V, resistive load = 1 $\Omega$ , gate pulse = 10V, 100 $\mu\text{s}$ ;			400	mA
$V_{TM}$	$I_{TM} = 150\text{A}$ , $t_d = 10\text{ ms}$ , half sine			2.1	V
$P_{GM}$	$t_p \leq 5\text{ms}$ , $T_J = 125^{\circ}\text{C};$			10	W
$P_{GM(AV)}$	$f = 50\text{Hz}$ , $T_J = 125^{\circ}\text{C};$			2.5	W
$I_{GM}$	$t_p \leq 5\text{ms}$ , $T_J = 125^{\circ}\text{C};$			2.5	A
$-V_{GT}$				10	V
$V_{GT}$	$V_A = 6\text{V}$ , $R_A = 1\Omega$ , $T_J = -40^{\circ}\text{C};$			4	V
	$V_A = 6\text{V}$ , $R_A = 1\Omega;$			2.5	
	$V_A = 6\text{V}$ , $R_A = 1\Omega$ , $T_J = 125^{\circ}\text{C};$			1.7	
$I_{GT}$	$V_A = 6\text{V}$ , $R_A = 1\Omega$ , $T_J = -40^{\circ}\text{C};$			270	mA
	$V_A = 6\text{V}$ , $R_A = 1\Omega;$			140	
	$V_A = 6\text{V}$ , $R_A = 1\Omega$ , $T_J = 125^{\circ}\text{C};$			80	
$V_{GD}$	$V_{AK} = V_{DRM}$ , $T_J = 125^{\circ}\text{C}$			0.25	V
$I_{GD}$				6	mA
di/dt	$T_J = 25^{\circ}\text{C}$ , $V_D = 0.67V_{DRM}$ , $I_{TM} = 125\text{A}$ , $I_g = 500\text{mA}$ , $t_r < 0.5\ \mu\text{s}$ , $t_p > 6\ \mu\text{s}$			150	A/ $\mu\text{s}$

**THERMAL AND MECHANICAL CHARACTERISTICS** $T_C=25^{\circ}\text{C}$  unless otherwise specified

Symbol	Test Condition	value	Unit
$R_{thjc}$	DC operation, per junction;	0.6	K/W
$R_{THCS}$	Mounting surface smooth, flat and greased, per junction	0.15	K/W
Md	Mounting torque(M5)	3 to 5	N·m
	Terminal connection torque(M5)		
Weight	Typical value	27	g

**Characteristic curves**

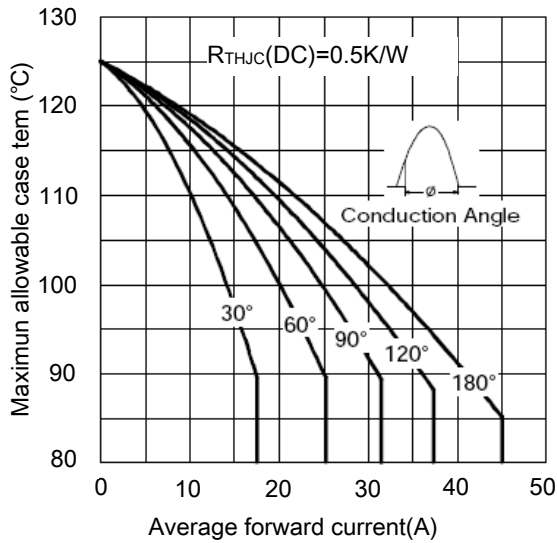


Figure 1. current rating characteristics

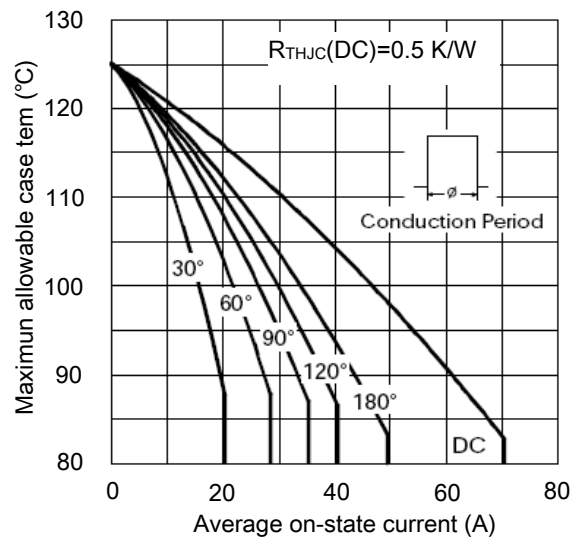


Figure 2. current rating characteristics

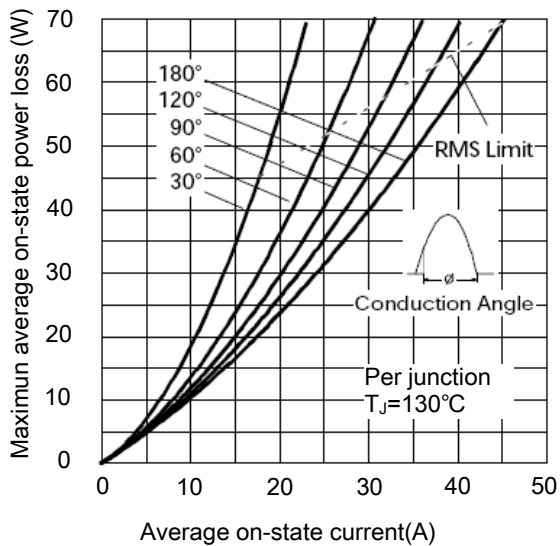


Figure 3. on-state power loss characteristics

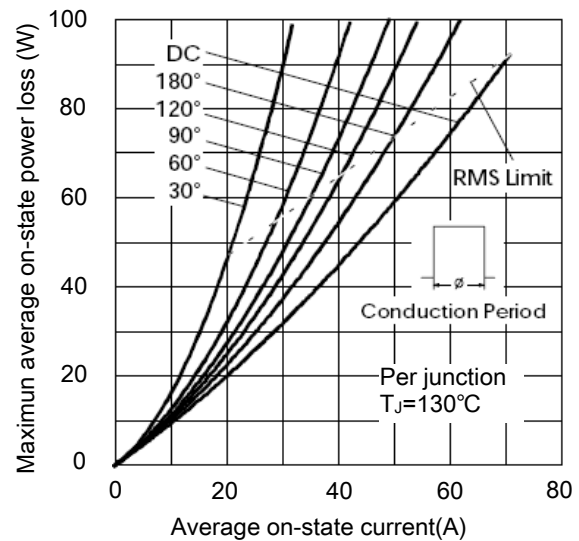


Figure 4. on-state power loss characteristics

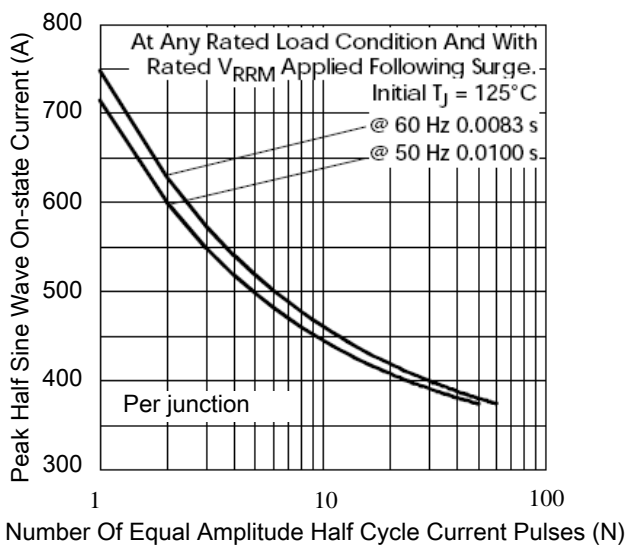


Figure 5. Maximum Non-Repetitive Surge Current

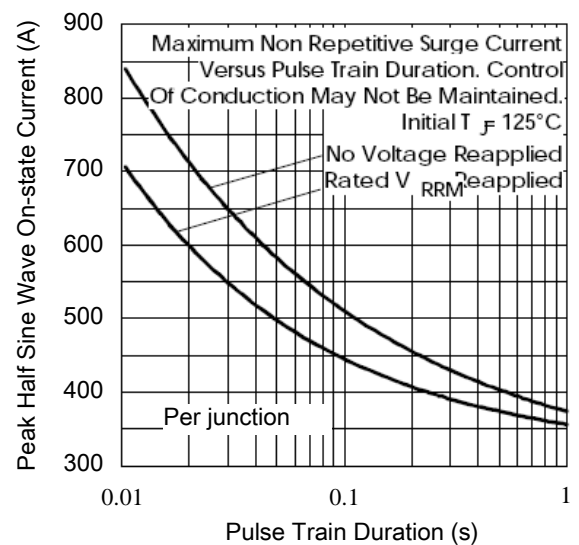


Figure 6. Maximum Non-Repetitive Surge Current

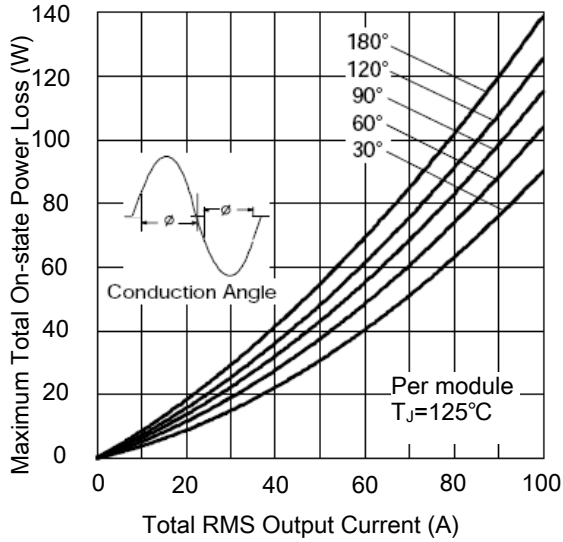


Figure 7. On-State Power Loss Characteristics-1

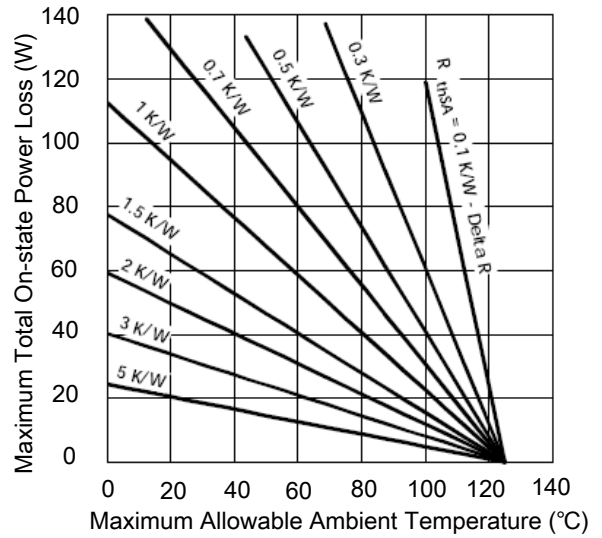


Figure 8 On-State Power Loss Characteristics-2

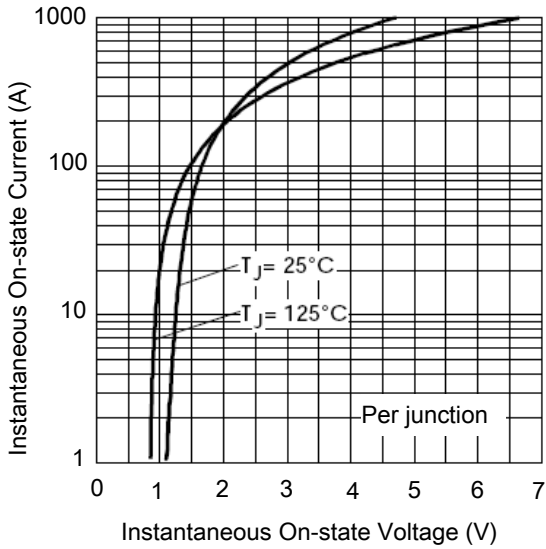


Figure 9 On State Voltage Drop Characteristics

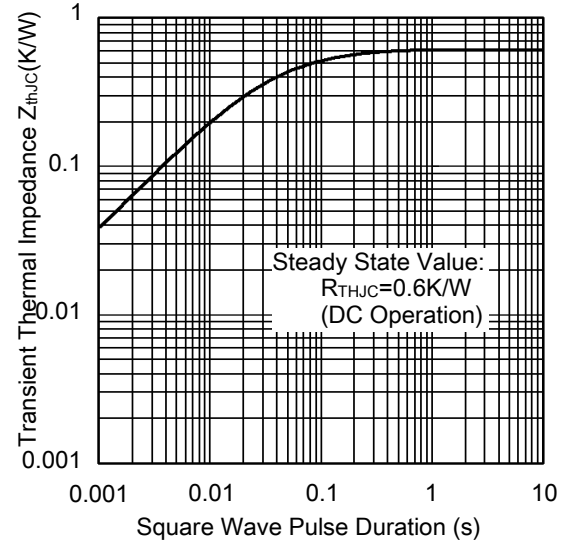


Figure 10 Thermal Impedance ZthJC Characteristics

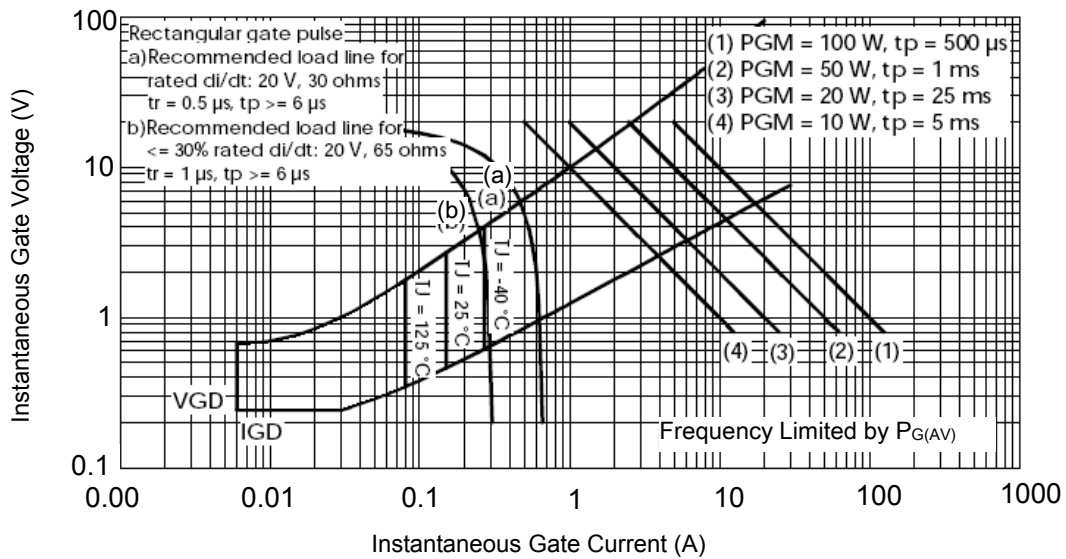


Figure 11 Gate Characteristics

## Package Outline (Dimensions in mm)

